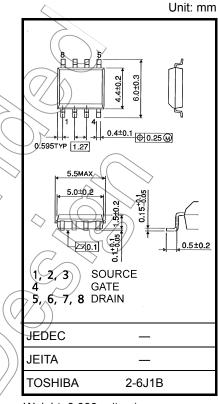
TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIII)

# **TPC8107**

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance:  $RDS(ON) = 5.5 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance:  $|Y_{fs}| = 31 \text{ S (typ.)}$
- Low leakage current:  $IDSS = -10 \mu A (max) (VDS = -30 V)$
- Enhancement mode:  $V_{th} = -0.8 \text{ to } -2.0 \text{ V } (V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA})$

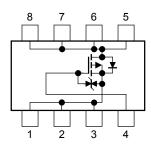


Weight: 0.080 g (typ.)

## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-source voltage			$V_{DSS}$	-30	y
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )			V <sub>DGR</sub>	-30	//
Gate-source voltage			V <sub>GS</sub> S	±20	X
Drain current	DC	(Note 1)	I <sub>D</sub> /	)) –13	A
	Pulse	(Note 1)	TOP (	<b>−52</b> ⟨	`
Drain power dissipation (t = 10 s) (Note 2a)			PD	1.9	( <u>\$</u>
Drain power dissipation (t = 10 s) (Note 2b)			PD	(1.0)	w
Single pulse avalanche energy (Note 3)			EAS	219	mJ
Avalanche current			I <sub>AR</sub>	-13	Α
Repetitive avalanche energy (Note 2a) (Note 4)			EAR	0.19	mJ
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

## **Circuit Configuration**



Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the next page.

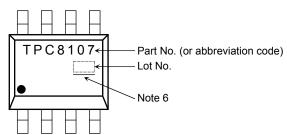
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

#### **Thermal Characteristics**

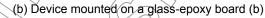
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	65.8	°C/W	
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W	

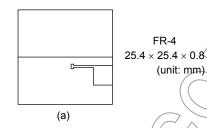
#### Marking (Note 5)

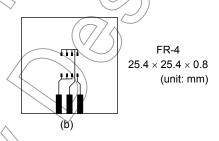


Note 1: Ensure that the channel temperature does not exceed 150°C

Note 2: (a) Device mounted on a glass-epoxy board (a)







Note 3:  $V_{DD} = -24 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial),  $L \neq 1.0 \text{ mH}$ ,  $R_G = 25 \Omega$ ,  $A_R = -13 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

Weekly code: (Three digits)

Week of manufacture
(01 for first week of year, continuing up to 52 or 53)

Year of manufacture
(The last digit of the calendar year)

Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

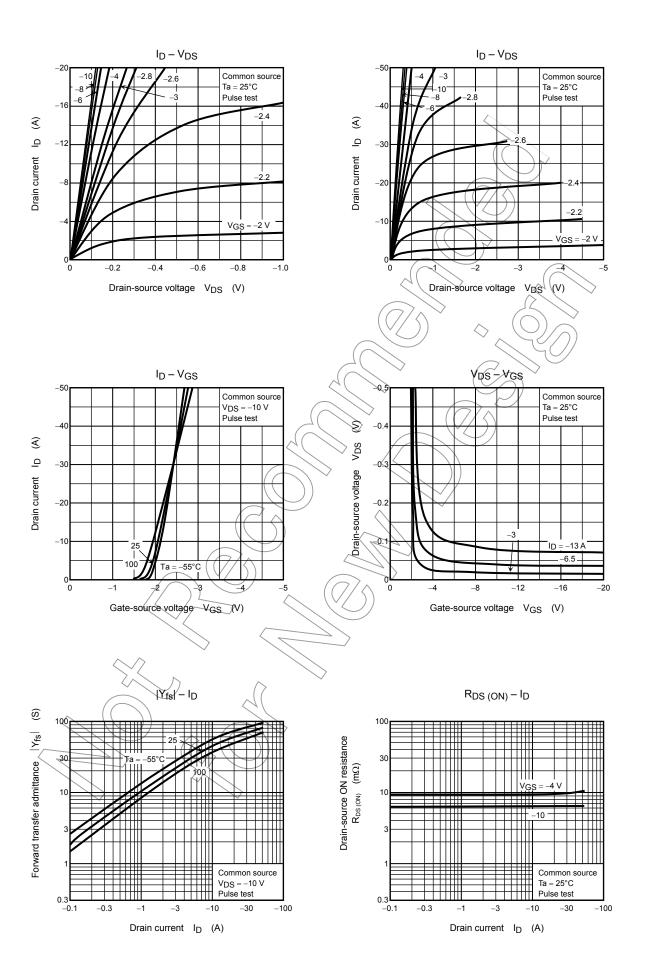
## **Electrical Characteristics (Ta = 25°C)**

Ch	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rrent	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cut-OFF cu	ırrent	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$		_	-10	μА
Drain-source breakdown voltage		V <sub>(BR) DSS</sub>	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	15		_	V
Gate threshold v	oltage	V <sub>th</sub>	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	0.8	) >-	-2.0	V
Drain-source ON resistance		R <sub>DS (ON)</sub>	$V_{GS} = -4 \text{ V}, I_D = -6.5 \text{ A}$	)   	10	15	- mΩ
			$V_{GS} = -10 \text{ V}, I_D = -6.5 \text{ A}$	)	5.5	7.0	
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -6.5 \text{ A}$	15.5	31	_	S
Input capacitance		C <sub>iss</sub>		_	5880	_	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	1000	_	pF
Output capacitan	ice	Coss			(1050	7	
Switching time	Rise time	t <sub>r</sub>	0 V 7 ( Ip ≠ −6.5 A <	-(	)11	> _	
	Turn-ON time	t <sub>on</sub>	V <sub>GS</sub> 0 V 10 ± -6.5 A VOUT		22	_	20
	Fall time	t <sub>f</sub>	4.4 4.4 4.4 4.4 4.4 4.4 4.4 4.4 4.4 4.4		110	_	ns
	Turn-OFF time	t <sub>off</sub>	V <sub>DD</sub> ≃ 15V Duty ≦ 1%, t <sub>W</sub> = 10 μs	) —	395	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -24 \text{ V}, V_{GS} = -10 \text{ V},$	_	130	_	
Gate-source charge 1		Q <sub>gs1</sub>	$I_D = -13 \text{ A}$	_	10	_	nC
Gate-drain ("miller") charge		Qgd		_	30	_	

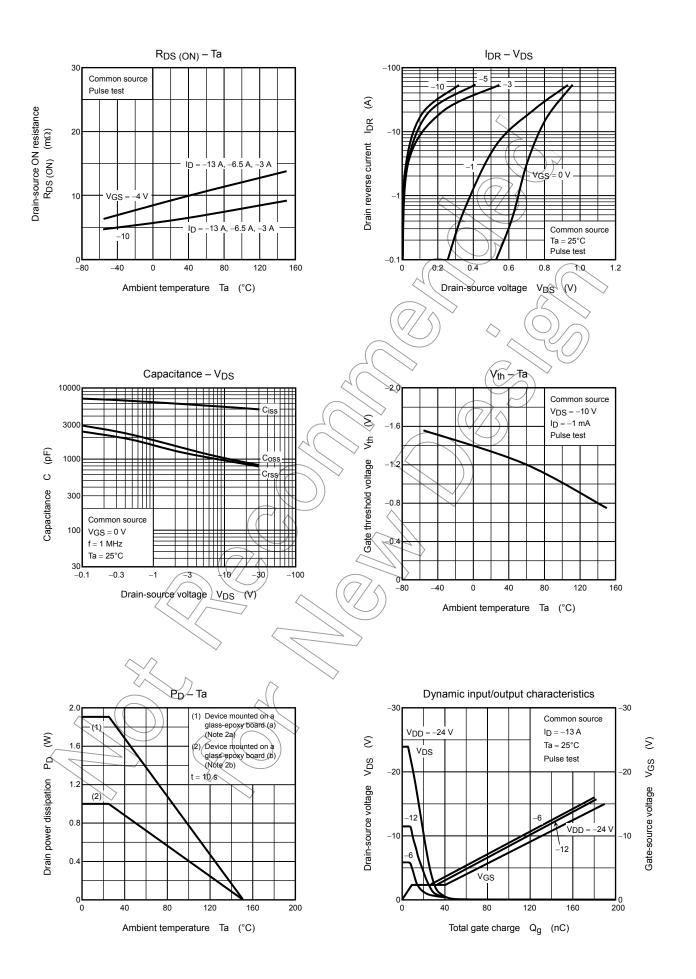
# Source-Drain Ratings and Characteristics (Ta = 25°C)

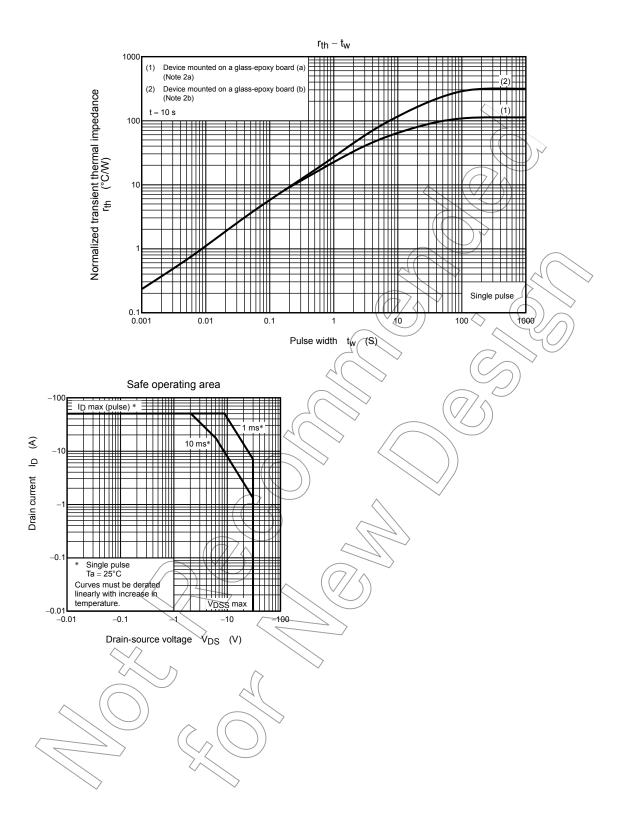
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note-1)	I <sub>DRP</sub>	_	_	_	-52	Α
Forward voltage (diode)	VDSE	$I_{DR} = -13 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V





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